MOSFET – Power, Single, N-Channel, SO-8 FL 30 V, 38 A

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Optimized Gate Charge to Minimize Switching Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- CPU Power Delivery
- DC-DC Converters

MAXIMUM RATINGS (T_J = $25^{\circ}C$ unless otherwise stated)

Parameter		Symbol	Value	Unit	
Drain-to-Source Voltage		V _{DSS}	30	V	
Gate-to-Source Voltage		V _{GS}	±20	V	
Continuous Drain Current R _{θJA}		$T_{A} = 25^{\circ}C$ $T_{A} = 80^{\circ}C$	Ι _D	13.0 9.7	А
(Note 1) Power Dissipation R _{0JA} (Note 1)		$T_A = 25^{\circ}C$	P _D	2.46	w
Continuous Drain Current $R_{\theta JA} \le 10$ s		T _A = 25°C T _A = 80°C	I _D	19.1 14.3	A
$\begin{array}{l} \mbox{(Note 1)} \\ \mbox{Power Dissipation} \\ \mbox{R}_{\theta,JA} \leq 10 \ \mbox{s (Note 1)} \end{array}$	Steady State	$T_A = 25^{\circ}C$	P _D	5.32	w
Continuous Drain		T _A = 25°C	۱ _D	7.2	Α
Current R _{θJA} (Note 2)		$T_A = 80^{\circ}C$		5.4	
Power Dissipation $R_{\theta JA}$ (Note 2)		$T_A = 25^{\circ}C$	PD	0.75	W
Continuous Drain Current $R_{\theta JC}$		$T_{\rm C} = 25^{\circ}{\rm C}$	Ι _D	38	A
(Note 1)		T _C =80°C		29	
Power Dissipation $R_{\theta JC}$ (Note 1)		T _C = 25°C	PD	21.6	W
Pulsed Drain Current	$T_{A} = 25^{\circ}$	°C, t _p = 10 μs	I _{DM}	106	Α
Current Limited by Pa	ickage	$T_A = 25^{\circ}C$	I _{Dmax}	70	Α
Operating Junction and Storage Temperature		T _J , T _{STG}	–55 to +150	°C	
Source Current (Body Diode)		ا _S	19	Α	
Drain to Source DV/DT		dV/d _t	7.0	V/ns	
Energy (T _J = 25°C, V	Single Pulse Drain-to-Source Avalanche Energy (T _J = 25°C, V _{GS} = 10 V, I _L = 21 A _{pk} , L = 0.1 mH, R _{GS} = 25 Ω) (Note 3)		E _{AS}	22	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.

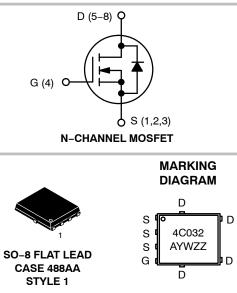
2. Surface-mounted on FR4 board using the minimum recommended pad size.



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
30 V	7.35 mΩ @ 10 V	38 A
30 V	11.15 mΩ @ 4.5 V	30 A



A = Assembly Location Y = Year W = Work Week

ZZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFS4C032NT1G	SO-8 FL (Pb-Free)	1500 / Tape & Reel
NTMFS4C032NT3G	SO-8 FL (Pb-Free)	5000 / Tape & Reel

+ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

3. This is the absolute maximum rating. Parts are 100% tested at T_J = 25°C, V_{GS} = 10 V, I_L = 15 Apk, E_{AS} = 11 mJ.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain)	$R_{ extsf{ heta}JC}$	5.8	
Junction-to-Ambient - Steady State (Note 4)	R_{\thetaJA}	50.8	°C/W
Junction-to-Ambient - Steady State (Note 5)	R_{\thetaJA}	166.6	-C/W
Junction-to-Ambient – (t \leq 10 s) (Note 4)	R_{\thetaJA}	23.5	

Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.
Surface-mounted on FR4 board using the minimum recommended pad size.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		30			V
Drain-to-Source Breakdown Voltage (transient)	V _{(BR)DSSt}	V_{GS} = 0 V, $I_{D(aval)}$ = 6.1 A, T_{case} = 25°C, $t_{transient}$ = 100 ns		34			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				14.9		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$			1.0	μΑ
		V _{DS} = 24 V	T _J = 125°C			10	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS}$	= ±20 V			±100	nA
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$		1.3		2.1	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				4.8		mV/°0
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 30 A		6.11	7.35	
		V _{GS} = 4.5 V	I _D = 12 A		9.29	11.15	mΩ
Forward Transconductance	9 _{FS}	V _{DS} = 1.5 V, I _D = 15 A			40		S
Gate Resistance	R _G	T _A = 25°C		0.3	1.0	2.0	Ω
CHARGES AND CAPACITANCES					-		
Input Capacitance	C _{ISS}				770		pF
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1 MH:	z, V _{DS} = 15 V		443		
Reverse Transfer Capacitance	C _{RSS}				127		1
Capacitance Ratio	C _{RSS} /C _{ISS}	V _{GS} = 0 V, V _{DS} = 15 V, f = 1 MHz			0.165		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 15 V; I _D = 30 A			7.8		nC
Threshold Gate Charge	Q _{G(TH)}				1.4		
Gate-to-Source Charge	Q _{GS}				2.9		
Gate-to-Drain Charge	Q _{GD}				3.7		
Gate Plateau Voltage	V _{GP}				3.6		V
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 15 V; I _D = 30 A			15.2		nC

SWITCHING CHARACTERISTICS (Note 7)

6. Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%.

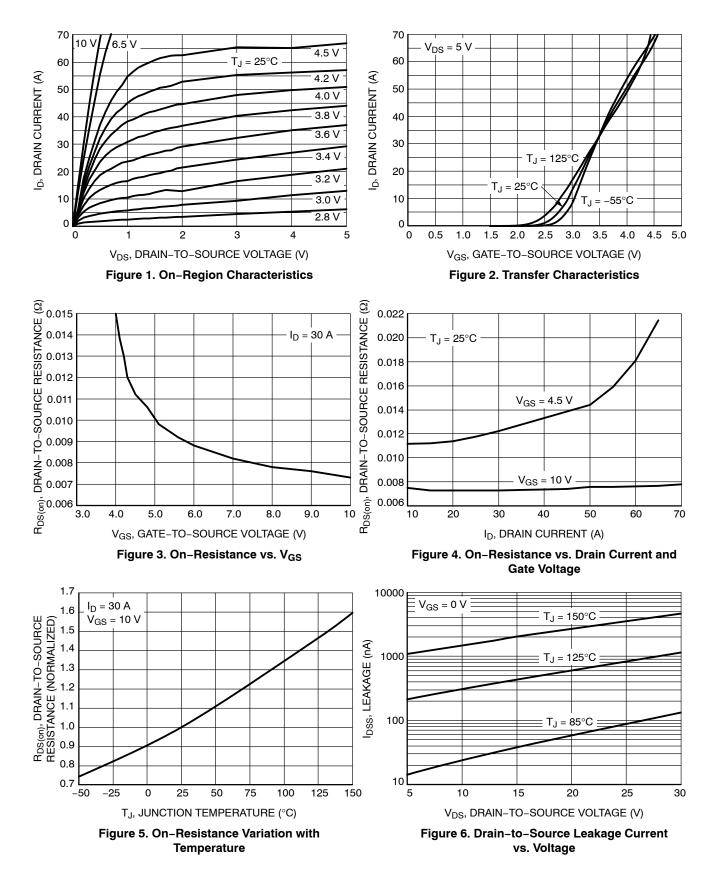
7. Switching characteristics are independent of operating junction temperatures.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

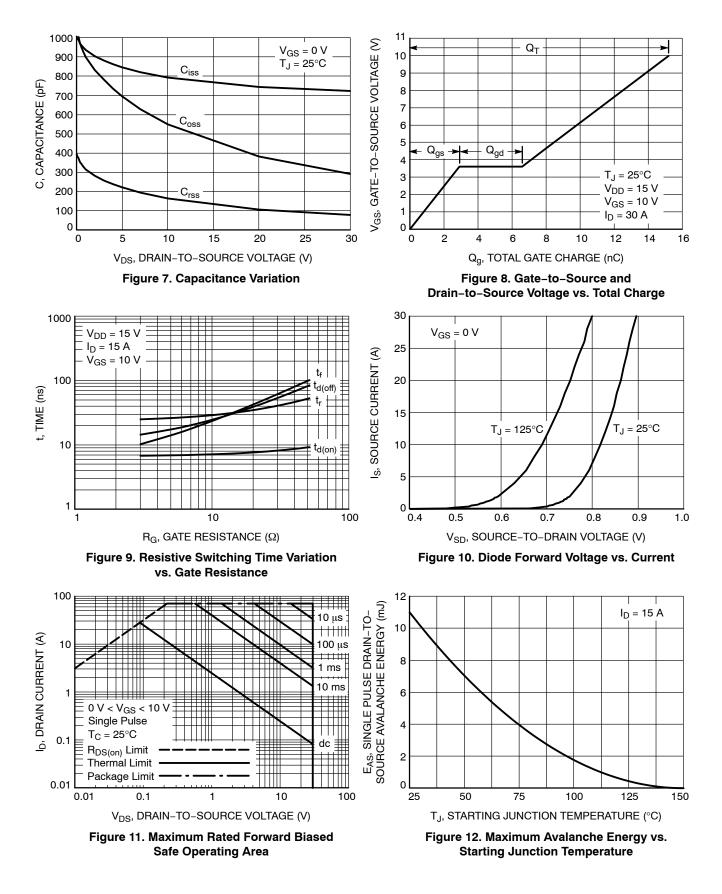
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS (N	lote 7)						
Turn-On Delay Time	t _{d(ON)}				9.0		
Rise Time	t _r	V _{GS} = 4.5 V, V _D	_S = 15 V,		35		
Turn-Off Delay Time	t _{d(OFF)}	V_{GS} = 4.5 V, V_{DS} = 15 V, I _D = 15 A, R _G = 3.0 Ω			13		ns
Fall Time	t _f				5.0		
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V_{DS} = 15 V, I _D = 15 A, R _G = 3.0 Ω			6.0		ns
Rise Time	t _r				26		
Turn-Off Delay Time	t _{d(OFF)}				16		
Fall Time	t _f				3.0		
DRAIN-SOURCE DIODE CHARACT	ERISTICS						
Forward Diode Voltage	V _{SD}	VGS – UV,	$T_J = 25^{\circ}C$		0.82	1.1	
			T _J = 125°C		0.69		V
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/μs, I _S = 30 A			23.4		
Charge Time	t _a				12.1		ns
Discharge Time	t _b				11.3		
Reverse Recovery Charge	Q _{RR}				9.7		nC

 $\begin{array}{ll} \mbox{6. Pulse Test: pulse width } \le 300 \ \mu \mbox{s, duty cycle } \le 2\%. \\ \mbox{7. Switching characteristics are independent of operating junction temperatures.} \end{array}$

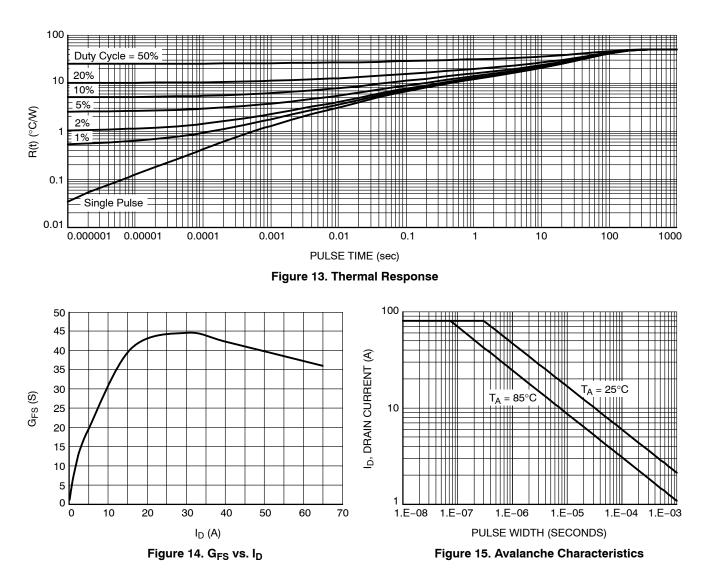
TYPICAL CHARACTERISTICS



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